Anti Static Polyimide Film Silicone Tape HB836 TECHNICAL DATA

| ITEM | UNIT | PROPERTY DATA |
|------------------------|--------|---|
| Structure | - | - PI Film (25µm) - Copper Metallizing - Silicone Adhesive |
| Base Film Thickness | μm | 25 |
| Total Thickness | μm | 50 ± 5 |
| Peel Strength | g/in | 630 |
| Tensile Strength | kg/mm² | > 3.5 |
| Feature & Use | | Anti Static PI Film Silicone Tape |

Unless stated otherwise all values given are average. All of the tapes in our range should be thoroughly tested on the substrates in the particular application they are intended for. Hi-Bond Tapes Ltd. will not be responsible for product failure unless full testing has been completed. The customer has to decide on the tapes suitability for the intended application.